



LAURENT BOSSON
Executive Vice President
Front-End Technology and Manufacturing
STMicroelectronics

Laurent Bosson was born in Mieussy, near Chamonix, France, in 1942 and graduated with degrees in chemistry and physics from the University of Dijon, France.

A French national, he began his professional career in 1964 with THOMSON-CSF. In 1985, he joined the French subsidiary of SGS Microelettronica as General Manager of the semiconductor devices manufacturing plant in Rennes, France.

After the merger of SGS Microelettronica and Thomson Semiconducteurs into SGS-THOMSON Microelectronics (now STMicroelectronics), Bosson remained in Rennes until 1989, when he was appointed Corporate Vice President and Director of Central Manufacturing. His responsibilities were soon expanded to include all MOS VLSI and mixed-technology Fabs. He set up a broad rationalization program, vital after a merger of such importance, which resulted in improved manufacturing costs and a consolidation of processes and technologies. Under his leadership, the Front-End manufacturing machine of STMicroelectronics substantially progressed and expanded, and became one of the key success factors of the Company.

In January 1992, Bosson also became President and CEO of the Company's operation in the Americas. A believer in Total Quality Management, he expanded and implemented this concept from the manufacturing lines into all other areas of the US Company. He oversaw the opening and ramp-up of a leading-edge eight-inch (200mm) wafer Fab with sub-micron capability in Phoenix, Arizona.

In 1995 he received the mission to set up and start the third eight-inch (200mm) submicron module of the Company in Catania, Sicily, followed by Rousset 200mm and Singapore 200mm in 1997. Under his direction the Front-End Manufacturing organization is presently ramping up 65nm CMOS Logic in a new twelve-inch (300mm) Fab in Crolles, France. Additional sizable investments, like a new 12" Fab in Catania, Sicily, are continuously being made throughout the world to keep the Fabs world class in quality and cost efficiency.

Following a re-organization of the Company in January 2005, a new Front-End Technology and Manufacturing entity was created in line with ST's position as a major player in the development of innovative products, manufactured in leading-edge technology. This new entity reflected the growing interconnection of these two key functions for advanced microelectronics and was placed under the direction of Bosson, thus expanding his responsibilities. He also became Executive Vice President following the formation of the ST Corporate Executive Committee, comprised of six corporate executives in addition to the COO and the CEO.

Laurent Bosson has held the position of Chairman of the Board of the US subsidiary company, STMicroelectronics, Inc since 1996.

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